

Abundance Enterprise Co. PRODUCT SPECIFICATION

CERAMIC RESONATOR

AEC PART NUMBER / SPEC. NO: ZTTCP2.00MG

CUSTOMER:



Peak soldering temperature 260°C/10 sec
Ceramic component is exempted (According to ROHS directive 2005/95/EC ANNEX point 7)

Customer's Name	
Production Name	Ceramic Resonator
Frequency	2.00MHz
Model No	ZTTCP2.00MG
Issue Date	15 th Oct, 2013

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128 Java Road,

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Prepared	Inspection	Approved	
	Andy	Henkie	

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1 Toduct Specification	PN:	ZTTCP

1. SCOPE

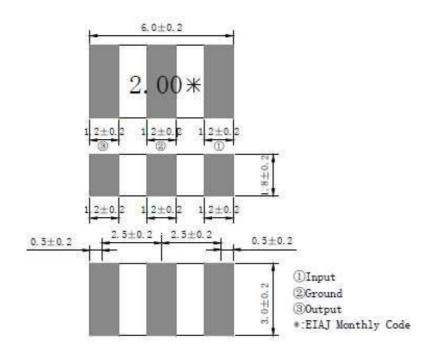
This specification shall cover the characteristics of the ceramic resonator with the type ZTTCP2.00MG

2. PART NO.:

PART NUMBER	CUSTOMER PART NO	SPECIFICATION NO
ZTTCP2.00MG		

3. OUTLINE DRAWING AND DIMENSIONS:

- 3.1 Appearance: No visible damage and dirt.
- 3.2 Dimensions:



UINT: mm

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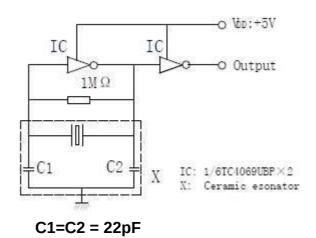
4. ELECTRICAL SPECIFICATIONS:

		Requirements	
4.1	Oscillation Frequency Fosc	2.00	
	(MHz))		
	Frequency Accuracy (%)	±0.5	
4.2	Resonant Impedance Ro	100	
	(ΩQmax		
4.3	Temperature Coefficient of	±0±3 (Oscillation	
	Oscillation Frequency (%) max	Frequency drift -20°C°	
		+85°C)°C	
4.4	Withstanding Voltage	100 VDC, 5 sec	
4.5	Rating Voltage U_R (V)		
	(1) D.C. Voltage	6 VDC.	
	(2) A.C. Voltage	15 Vp-p.	
4.6	Insulation Resistance Ri, (ΜΩΩ min	500 (10V, 1min)	
4.7	Operating Temperature (°C)°C	-20 ~ + 85	
4.8	Storage Temperature $(C)^{\circ}$ C	-55 ~ + 85	
4.9	Aging Rate (%) max	±0±1 From initial value	

Components shall be left in a chamber of $+85 \pm 2$ °C for 1000 hours, then measured after leaving in natural condition for 1 hours.

4. MEASUREMENT:

- 4.1 Measurement Conditions: Parts shall be measured under a condition (Temp.: 20±15°C, Mumidity: 65±20% R.H.) unless the standard condition (Temp.: 25±3°C, Mumidity: 65±5% R.H.) is regulated to measure.
- **4.2 Test Circuit:**



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5. PHYSICAL AND ENVIRONMENTAL CHARACTERISTICS

No	Item	Condition of Test		
				Requirements
6.1	Humidity	Keep the resonator at 40±2°C°and		It shall fulfill the
		90-95% RH for 96±4 hours. The	en Release	specifications in
		the resonator into the room Co	ondition	Table 1.
		for 1 hour prior to the Measure	ement.	
6.2	Vibration	Subject the resonator to vibrat	tion for 2	It shall fulfill the
		hours each in x , y and z axis	With the	specifications in
		amplitude of 1.5mm, the frequ	ency shall	Table 1.
		be varied uniformly between tl	ne limits of	
		10 Hz—55Hz.		
6.3	Mechanical	Drop the resonator randomly o	onto a	It shall fulfill the
	Shock	wooden floor from the height of	of 100cm 3	specifications in
		times.		Table 1.
6.4	Soldering	Passed through the re-flow ov	en under	It shall fulfill the
	Test	the following condition and lef	t at room	specifications in
		temperature for 1 hour before		Table 1.
		measurement.		
		Temperature at the surface of	Time	
		the substrate		
		Preheat 150±5℃°C	60±10	
			sec	
		Peak 260±5°C°C	10±3 sec	
6.5	Solder	Dipped in 250±5°C°©older bath	for 3±0.5	The terminals shall
	Ability	sec seconds with rosin flux (2	5wt%	be at least 95%
		ethanol solution.)		covered by solder.
6.6	High	Subject the resonator to 80±5°	C°tor 96	It shall fulfill the
	Temperature	hours, then release the resona	itor into	specifications in
	Exposure	the room conditions for 1 hou	r prior to	Table 1.
		the measurement.		
6.7	Low	Subject the resonator to -20±5	°C°for 96	It shall fulfill the
	Temperature	hours, then release the resona		specifications in
	Exposure	the room conditions for 1 hour prior to the measurement.		Table 1.

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	Item	Condition of Test	
	ito	Contained of Fest	Requirements
6.8	Temperature	Subject the resonator to -40°C°for 30	It shall fulfill the
	Cycling	min. followed by a high temperature of	specifications in
		85℃℃ @r 30 min.	Table 1.
		Cycling shall be repeated 5 times with a	
		transfer time of 15 sec. At the room	
		temperature for 1 hour prior to the	
		measurement.	
6.9	Board	Mount a glass-epoxy board	Mechanical
	Bending	(Width=40mm,thickness=1.6mm),then	damage such as
		bend it to 1mm displacement and keep it	breaks shall not
		for 5 seconds. (See the following figure)	occur.
		PRESS	
		20	
		PRESS HEAD	
		R F	
		D.U.T. of	
		1.0±0.	
		45±2 45±2 45±2 65 SUPPORT BAR	
		7.50 3011 3111 .	

TABLE 1

Item	Specification
Oscillation Frequency	±0.3
Change	
<u>∧</u> Fosc/Fosc (%) max	
Resonant Impedance	105
Ro(ΩΩmax	105

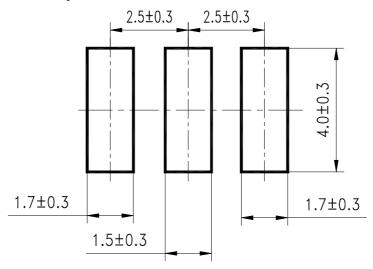
Note: The limits in the above table are referenced to the initial measurements.

6. REVIEW OF SPECIFICATIONS

When something gets doubtful with this specifications, we shall jointly work to get an agreement.

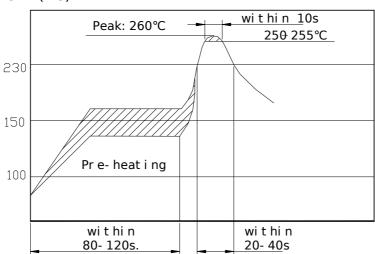
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8.1Recommended land pattern



8.2 Recommended reflow soldering standard conditions





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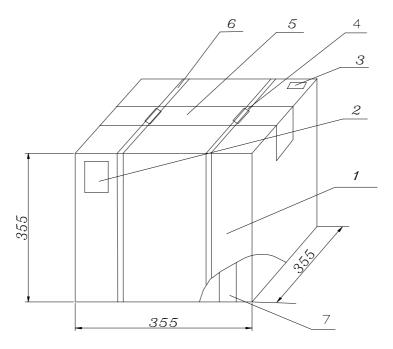
8. PACKAGE

To protect the products in storage and transportation , it is necessary to pack them (outer and inner package). On paper pack, the following requirements are requested.

8.1 Dimensions and Mark

At the end of package, the warning (moisture proof, upward put) should be stick to it.

Dimensions and Mark (see below)



NO.	Name	Quantity	Notes
1	Package	1	
2	Certificate of approval	1	
3	Label	1	
4	Tying	2	
5	Adhesive tape	1.2m	
6	Belt	2.9m	
7	Inner Box	10	

8.2 Section of package

Package is made of corrugated paper with thickness of 0.8cm. Package has 10 inner boxes, each box has 1 reel (each reel for plastic bag).

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8.3 Quantity of package

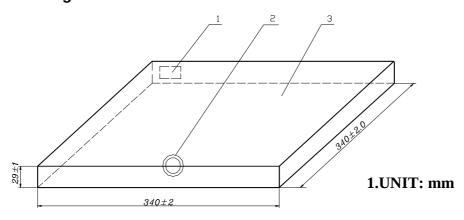
Per plastic reel 4000 pieces of piezoelectric ceramic part

Per inner box 1 reel

Per package 10 inner boxes(40000 pieces of piezoelectric

ceramic part))

8.4 Inner Packing Dimensions

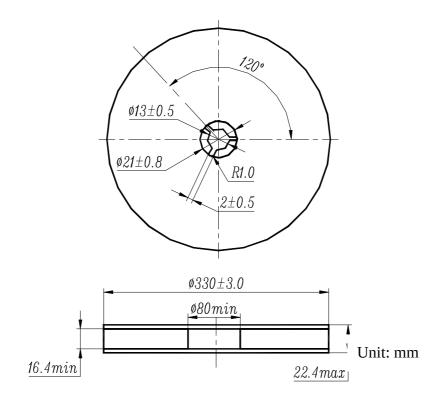


1	Label
2	QC Label
3	Inner Box

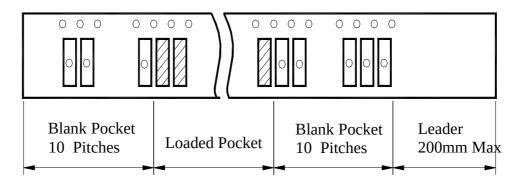
Pars shall be packaged in box with hold down tape upside. Part No., quantity and lot No.

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8.5 Reel



8.6 Packing Method Sketch Map



8.7 Test Condition Of Peeling Strength

